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May 2015



## FDMS86540

# N-Channel PowerTrench<sup>®</sup> MOSFET 60 V, 129 A, 3.4 m $\Omega$

#### **Features**

- Max  $r_{DS(on)} = 3.4 \text{ m}\Omega$  at  $V_{GS} = 10 \text{ V}$ ,  $I_D = 20 \text{ A}$
- Max  $r_{DS(on)} = 4.1 \text{ m}\Omega$  at  $V_{GS} = 8 \text{ V}$ ,  $I_D = 18.5 \text{ A}$
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

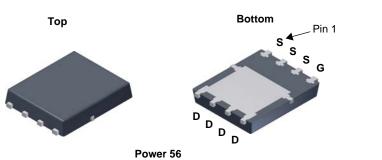


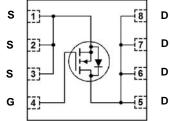
## **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers.It has been optimized for low gate charge, low  $r_{\rm DS(on)},$  fast switching speed and body diode reverse recovery performance.

## **Applications**

- Primary Switch in isolated DC-DC
- Synchronous Rectifier
- Load Switch





## **MOSFET Maximum Ratings** T<sub>A</sub> = 25 °C unless otherwise noted.

Symbol	Param	eter		Ratings	Units
$V_{DS}$	Drain to Source Voltage			60	V
V <sub>GS</sub>	Gate to Source Voltage			±20	V
	Drain Current -Continuous	T <sub>C</sub> = 25 °C	(Note 5)	129	
	-Continuous	T <sub>C</sub> = 100 °C	(Note 5)	82	^
'D	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	20	Α
	-Pulsed		(Note 4)	642	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	228	mJ
$P_{D}$	Power Dissipation	T <sub>C</sub> = 25 °C		96	w
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	VV
$T_J, T_{STG}$	Operating and Storage Junction Tempera	ature Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	50	C/VV

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86540	FDMS86540	Power 56	13 "	12 mm	3000 units

©2012 Fairchild Semiconductor Corporation FDMS86540 Rev. 1.4

## **Electrical Characteristics** $T_J = 25$ °C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	60			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		28		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 48 V, V <sub>GS</sub> = 0 V			1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA

#### On Characteristics

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2	3.2	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		-11		mV/°C
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		2.7	3.4	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 8 V, I <sub>D</sub> = 18.5 A		3.1	4.1	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 125 \text{ °C}$		3.8	4.8	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 20 A		73		S

### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V 00 V V 0 V	4837	6435	pF
Coss	Output Capacitance	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHz	1413	1880	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1 101112	50	90	pF
R <sub>a</sub>	Gate Resistance		1.0		Ω

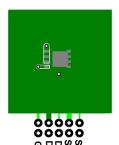
### **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		28	45	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 20 A,	16	29	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$	32	52	ns
t <sub>f</sub>	Fall Time		7.2	15	ns
$Q_g$	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V	65	90	nC
Qg	Total Gate Charge	$V_{GS} = 0 \text{ V to 8 V}$ $V_{DD} = 30 \text{ V},$	53	75	nC
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 20 A	23		nC
$Q_{gd}$	Gate to Drain "Miller" Charge		12		nC

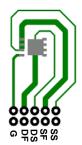
#### **Drain-Source Diode Characteristics**

V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 2.1 \text{ A}$ (N	Note 2)	0.70	1.2	V
	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 20 \text{ A}$ (N	Note 2)	0.79	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 20 A, di/dt = 100 A/μs		55	88	ns
Q <sub>rr</sub>	Reverse Recovery Charge	- 1 <sub>F</sub> = 20 A, αι/αι = 100 A/μS		41	66	nC
t <sub>rr</sub>	Reverse Recovery Time	-I <sub>F</sub> = 20 A, di/dt = 300 A/μs		44	70	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$I_F = 20 \text{ A}, \text{ di/dt} = 300 \text{ A/}\mu\text{S}$		76	122	nC

Notes:
1. R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0CA</sub> is determined by the user's board design.



a) 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

- 2. Pulse Test: Pulse Width < 300  $\mu\text{s},$  Duty cycle < 2.0%.
- 3. Starting T<sub>J</sub> = 25 °C, L = 0.3 mH, I<sub>AS</sub> = 39 A, V<sub>DD</sub> = 54 V, V<sub>GS</sub> = 10 V. 100% test at L = 0.1 mH, I<sub>AS</sub> = 57 A.
- 4. Pulse Id please refer to SOA curve for more details.
- 5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

## **Typical Characteristics** $T_J = 25$ °C unless otherwise noted.

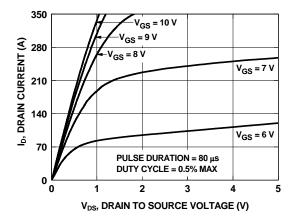


Figure 1. On-Region Characteristics

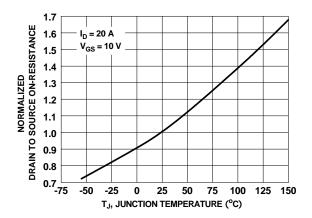


Figure 3. Normalized On-Resistance vs. Junction Temperature

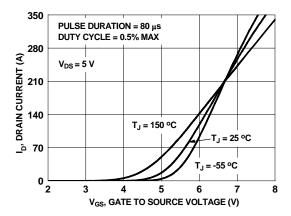


Figure 5. Transfer Characteristics

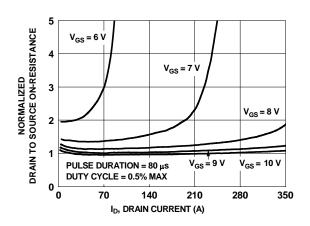


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

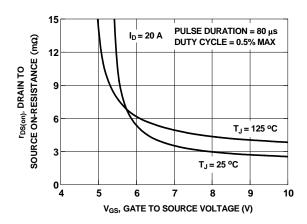


Figure 4. On-Resistance vs. Gate to Source Voltage

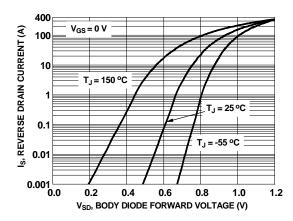


Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

## Typical Characteristics $T_J = 25 \, ^{\circ}\text{C}$ unless otherwise noted.

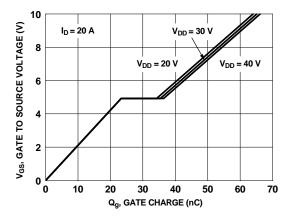


Figure 7. Gate Charge Characteristics

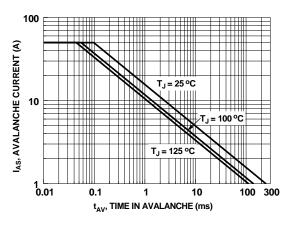


Figure 9. Unclamped Inductive Switching Capability

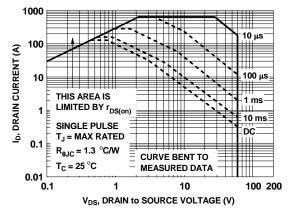


Figure 11. Forward Bias Safe Operating Area

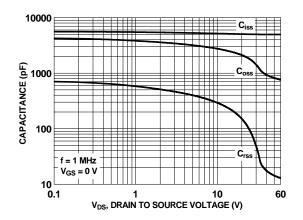


Figure 8. Capacitance vs. Drain to Source Voltage

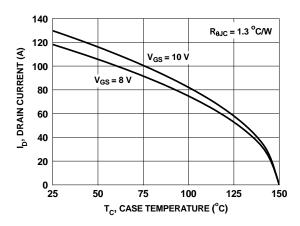


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

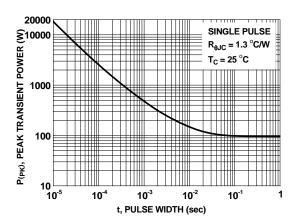


Figure 12. Single Pulse Maximum Power Dissipation

## **Typical Characteristics** $T_J = 25$ °C unless otherwise noted.

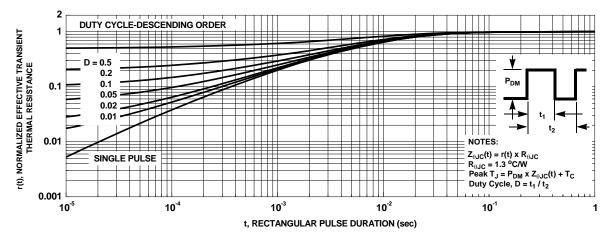
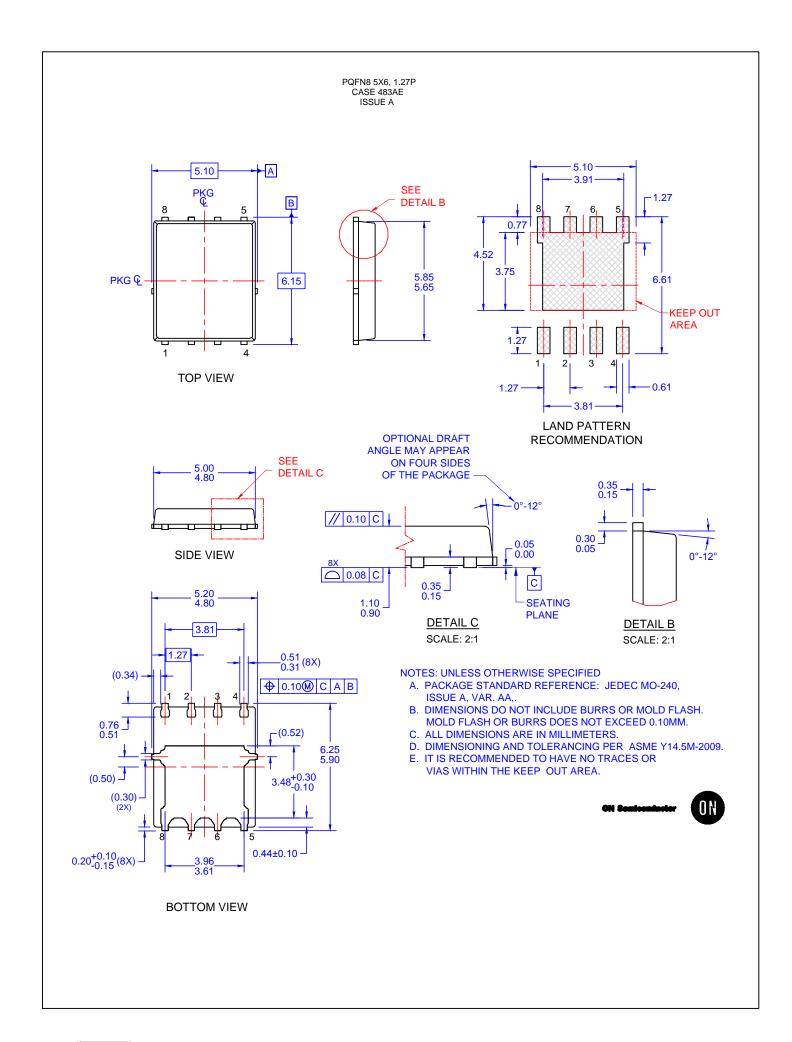


Figure 13. Junction-to-Case Transient Thermal Response Curve



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